

### REMARKS

Applicant requests favorable reconsideration and allowance of the subject application in view of the preceding amendments and the following remarks.

To place the application in better form, Applicant submits herewith a substitute specification, which includes a new abstract, as required by the Examiner. For the Examiner's convenience, also provided is a marked-up copy of the original specification showing the portions thereof which are being changed. The substitute specification includes the same changes as are indicated in the marked-up copy. Applicant's undersigned attorney has reviewed the substitute specification and submits that the substitute specification contains no new matter.

Claims 1-8, 10 and 11 are now presented for consideration. Claims 1, 10 and 11 are independent. Claim 9 has been cancelled without prejudice or disclaimer, while claims 1, 10 and 11 have been amended to clarify features of the invention. Support for these changes can be found in the original application as filed. Therefore, no new matter has been added.

Applicant requests favorable reconsideration and withdrawal of the objections and rejections set forth in the above-noted Office Action.

The Examiner required submission of a substitute specification, and correction of the Abstract and minor informalities in the specification. These matters have already been addressed in the substitute specification, discussed above.

Claims 1-11 were rejected under 35 U.S.C. § 112, first paragraph. The Examiner asserted that the subject matter of these claims was not adequately described in the subject specification. This contention is respectfully traversed. Nevertheless, to expedite prosecution, Applicant has amended independent claims 1, 10 and 11 in light of the Examiner's comments. Notably, Applicant has amended independent claims 1, 10 and 11 to clarify the features of the

emission angle conserving optical unit and the diffractive optical unit of the present invention. These claims now recite that the emission angle conserving optical unit has a lens array (independent claim 1) or a lens array and an aperture or a lens array (independent claims 10 and 11), and that the diffractive optical element is disposed at or adjacent to a position which is optically conjugate with a light exit surface of the emission angle conserving optical unit. Applicant submits that such features of the invention are adequately described and shown in the subject specification. Therefore, Applicant requests reconsideration and withdrawal of the rejection under 35 U.S.C. § 112, first paragraph.

Turning now to the art rejection, claims 1-11 were rejected under 35 U.S.C. § 102 as being anticipated by U.S. Patent No. 4,255,019 to Knop. Applicant submits that this patent does not teach many features of the present invention, as previously recited in claims 1-11. Therefore, this rejection is respectfully traversed. Nevertheless, Applicant submits that claims 1-8, 10, and 11, as presented, amplify the distinctions between the present invention and the cited art.

In one aspect of the invention, independent claim 1 recites an illumination system for illuminating a surface by use of light from a light source. The illumination system includes an emission angle conserving optical unit having a lens array for receiving light from the light source and a diffractive optical element for diffracting light to produce a desired light intensity distribution on a predetermined plane. The diffractive optical element is disposed at or adjacent to a position which is optically conjugate with a light exit surface of the emission angle conserving optical unit.

Independent claim 10, directed to an exposure apparatus, and independent claim 11, directed to a device manufacturing method, recite substantially similar features of the invention.

The Knop patent relates to a diffractive color filter made up of proximately disposed diffraction grating and lens structures, which may be embossed on a plastic sheet. The filter cooperates with an imaging lens to produce color stripes or color spots of an image on a photosensitive surface. The diffractive color filter may be used, for example, as a color-encoding stripe filter of a color TV camera.

Applicant submits, however, that the Knop patent does not teach or suggest the salient features of Applicant's present invention, as recited in independent claims 1, 10 and 11, including the arrangements of the emission angle conserving optical unit and the diffractive optical elements, in which the optical unit has a lens array (independent claim 1) or a lens and an aperture or a lens array (independent claims 10 and 11), in which the diffractive optical element is disposed at or adjacent to a position which is optically conjugate with a light exit surface of the emission angle conserving optical unit. Further, the Knop patent teaches neither an exposure apparatus nor a device manufacturing method. Therefore, Applicant submits that the Knop patent should not be read to anticipate Applicant's present invention recited in independent claims 1, 10 and 11.

For the reasons noted above, Applicant submits that the present invention, as recited in independent claims 1, 10 and 11, is patentably defined over the cited art.

Dependent claims 2-8 also should be deemed allowable, in their own right, for defining other patentable features of the present invention in addition to those recited in independent claim 1. Further individual consideration of these dependent claims is requested.

This Amendment After Final Rejection is believed to clearly place this application in condition for allowance. This Amendment was not presented earlier, because Applicant earnestly believed that the prior Amendment placed the subject application in condition for

allowance. Accordingly, entry of the instant Amendment, as an earnest attempt to advance prosecution and reduce the number of issues, is requested.

Applicant submits that this application is in condition for allowance, and a Notice of Allowance is respectfully requested.

Applicant's undersigned attorney may be reached in our Washington, D.C. office by telephone at (202) 530-1010. All correspondence should continue to be directed to our address listed below.

Respectfully submitted,

A handwritten signature in black ink, appearing to read "Steven E. Warner", with a horizontal line extending to the right.

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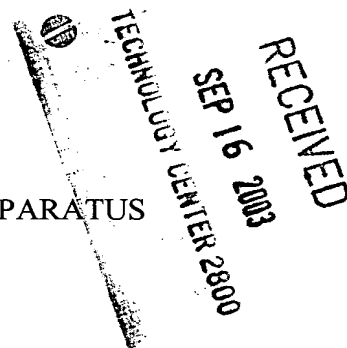


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*Marked-Up Substitute Specification*

Application No. 09/821,024

ILLUMINATION OPTICAL SYSTEM IN EXPOSURE APPARATUS



FIELD OF THE INVENTION AND RELATED ART

This invention relates to an illumination system and, more particularly, to an illumination system suitably usable in an illumination optical system of an exposure apparatus for the manufacture of semiconductor devices, which uses as a light source an excimer laser of a vacuum ultraviolet wavelength region.

In a lithographic process among semiconductor device manufacturing processes, an exposure process for transferring, by exposure, a very fine pattern such as an electronic circuit pattern formed on the surface of a mask onto a wafer is prepared plural times, whereby electronic circuits are produced on the wafer.

As regards the exposure method ~~use~~ used in the exposure process, there is a method in which a mask surface is held in contact ~~to~~ with or in close proximity to a wafer surface and, in this stage, the mask surface is illuminated so that the pattern of the mask is transferred to the wafer surface. Also, there is a method in which a mask (reticle) placed at a position optically conjugate with a wafer surface is illuminated, and a pattern formed on the mask surface is transferred onto a wafer surface, by projection exposure, through a projection optical system. In any exposure method, the image quality of a pattern transferred to a wafer

surface is largely influenced by the performance of the illumination system, for example, the uniformness of an illuminance distribution on the surface to be illuminated.

Figure 10 is a schematic view of a general structure of a conventional illumination system, and it includes an inner type integrator and an amplitude division type integrator such as disclosed in Japanese Laid-Open Patent Application, Laid-Open No. 270312/1998.

In Figure 10, laser light emitted by a laser light source 101 is once converged by a collimator lens 102 and then diverged, or alternatively, it is directly diverged by a negative lens, and the light is incident on an inside reflection surface of an optical pipe 103 at a predetermined divergent angle.

The divergent laser light having a divergent angle passes through the inside of the optical pipe 103 while being reflected thereby, and a plurality of apparent light source images of the laser light source 101 are produced on a plane (e.g., plane 110) perpendicular to the optical axis. Here, the laser beams, which appear as if they are emitted from the apparent light source images, are superposed one upon another on the light exit surface 103' of the optical pipe 103, such that a surface light source of uniform illuminance is produced at the light exit surface 103'. The light beam from the light exit surface 103' is directed by way of a condenser lens 104, an aperture stop 105 and a field lens 106, to the reticle 107 surface. Since the light exit surface 103' of the optical pipe 103 is in an optically conjugate relation with the reticle 107 surface, ~~also~~ the reticle 107 surface is also illuminated uniformly.

If the shape of the optical pipe 103 is determined while taking into account the length and width of the optical pipe 103 and the divergent angle of the laser light provided by the collimator lens 102, the optical path differences of each laser ~~beams~~ beam emitted from the apparent light sources at the plane 110 toward each of the points on the reticle 107 surface

can be more than the coherence length of the laser light. This reduces the coherence with respect to time, and prevents speckle on the reticle ~~17~~ 107 surface.

However, in the structure of the illumination system shown in Figure 10, a change in position of the light, to be caused frequently as a result of using a laser light source, may produce a variation in incidence angle of the light upon the surface being illuminated. This results in non-uniformness of illuminance, upon the surface being illuminated.

Further, in the illumination system of Figure 10, multiple reflection is made at the inside reflection surface of the optical pipe so as to increase the number of apparent light source images, by which uniform illuminance is attained. However, in order to assure the illuminance uniforming effect, the reflection times should be increased and, therefore, the optical pipe should have a sufficient length. Since, however, in the vacuum ultraviolet region, absorption of light by the glass material, that is, a decrease of transmission factor, is large, if an optical pipe of a length that assures sufficient illuminance uniformness is used, the efficiency of light utilization may be degraded as a result of it.

## SUMMARY OF THE INVENTION

It is accordingly an object of the present invention to provide an illumination system by which uniformness of a light intensity distribution upon a surface to be illuminated can be maintained even if light from a light source changes, and also by which the efficiency of light utilization is improved.

In accordance with an aspect of the present invention, there is provided an illumination system for illuminating a surface by use of light from a light source, said illumination system comprising: an emission angle conserving optical unit effective to emit

the light from the light source at a constant divergent angle; and a diffractive optical element for producing a desired light intensity distribution on a predetermined ~~plane~~; plane, wherein said diffractive optical element is disposed at or adjacent to a position where light from said emission angle conserving optical unit is collected.

In one preferred form of this aspect of the present invention, the illumination system may further comprise a multiple-beam producing element, and a light projecting element for superposing light beams from said multiple-beam producing element one upon another on the surface to be illuminated, wherein the predetermined plane corresponds to a light entrance surface of said multiple-beam producing element.

The illumination system may further comprise a zoom optical system for projecting the light intensity distribution, produced by said diffractive optical element, upon the light entrance surface of said multiple-beam producing element at a predetermined magnification.

There may be a plurality of emission angle conserving optical units of different divergent angles, and wherein said emission angle conserving optical units are interchangeably set at a light path in accordance with a change in magnification of said zoom optical system.

An emission angle conserving optical unit placed at the light path may be changed by another, whereby a numerical aperture of light incident on the light entrance surface of said multiple-beam producing element is substantially registered with a preset numerical aperture of said multiple-beam producing means.

There may be a plurality of diffractive optical elements for producing different light intensity distributions on the predetermined plane, wherein said diffractive optical elements



are interchangeably set at a light path to produce a desired light intensity distribution on the predetermined plane.

The diffractive optical element may be a phase type or an amplitude type computer hologram.

The emission angle conserving optical unit may comprise a fly's eye lens having small lenses arrayed ~~to~~ two-dimensionally.

The emission angle conserving optical unit may comprise an aperture and a lens system.

In accordance with another aspect of the present invention, there is provided an exposure apparatus, comprising: an illumination optical system for illuminating a mask surface, as a surface to be illuminated, with use of light from a light source, said illumination optical system including (i) an emission angle conserving optical unit effective to emit the light from the light source at a constant divergent angle, and (ii) a diffractive optical element for producing a desired light intensity distribution on a predetermined plane, wherein said diffractive optical element is disposed at or adjacent to a position where light from said emission angle conserving optical unit is collected; and a projection optical system for projecting a pattern formed on the mask surface, as illuminated with the light from said illumination optical system, onto a wafer.

In accordance with a further aspect of the present invention, there is provided a device manufacturing method, comprising the steps of: applying a photosensitive material to a wafer; illuminating a mask surface, as a surface to be illuminated, with use of light from an illumination optical system, wherein the illumination optical system includes (i) an emission angle conserving optical unit effective to emit the light from the light source at a constant

divergent angle, and (ii) a diffractive optical element for producing a desired light intensity distribution on a predetermined plane, wherein the diffractive optical element is disposed at or adjacent to a position where light from the emission angle conserving optical unit is collected; projecting, through a projection optical system, a pattern formed on the mask surface onto a wafer; and developing the transferred pattern.

These and other objects, features and advantages of the present invention will become more apparent upon a consideration of the following description of the preferred embodiments of the present invention taken in conjunction with the accompanying drawings.

#### BRIEF DESCRIPTION OF THE DRAWINGS

Figure 1 is a schematic view of a general structure of an illumination system according to an embodiment of the present invention.

Figures 2A and 2B are schematic views, respectively, each for explaining an emission angle conserving optical unit.

Figures 3A and 3B are schematic views, respectively, for explaining light incident on a diffractive optical element.

Figures 4A and 4B are schematic views, respectively, for explaining a phase type CGH as an example of a diffractive optical element.

Figures 5A, 5B and 5C are schematic views, respectively, for explaining examples of illuminance distributions to be produced by a diffractive optical element.

Figures 6A and 6B are schematic views, respectively, for explaining the interchanging of emission angle conserving optical units.

Figure 7 is a schematic view of a main portion of an exposure apparatus according to an embodiment of the present invention.

Figure 8 is a flow chart for explaining semiconductor device manufacturing processes.

Figure 9 is a flow chart for explaining details of a wafer process in the procedure of the flow chart of Figure 8.

Figure 10 is a schematic view of a general structure of a conventional illumination system.

#### DESCRIPTION OF THE PREFERRED EMBODIMENTS

Preferred embodiments of the present invention will now be described with reference to the accompanying drawings.

Figure 1 is a schematic view of an illumination system according to an embodiment of the present invention. Denoted in the drawing at 1 is a laser light source, and denoted at 2 is a light directing optical system. Denoted at 3 is a beam shaping optical system, and denoted at 4 and 6 are emission angle conserving optical units. Denoted at 5 is a condensing optical system, and denoted at 7 and 9 are relay optical systems. Denoted at 8 is an aperture stop, and denoted at 10 is a diffractive optical element. Denoted at 11 is a relay optical system, and denoted at 12 is an aperture. Denoted at 13 is a zoom optical system, and denoted at 14 is a multiple-beam producing means. Denoted at 15 is a light projecting means including a condenser lens and the like. Denoted at 16 is a ~~mark~~ mask or reticle (surface to be illuminated) having a circuit pattern formed thereon.

The laser light source 1 may be any one of various excimer lasers such as KrF, ArF, and F<sub>2</sub>, for example. The diffractive optical element 10 is a computer hologram designed to

produce a desired illuminance distribution (circular, ring-like or quadrupole shape, for example) at the position of the aperture 12, through the relay optical system 11. An amplitude type hologram, a phase distribution type hologram or a Kinoform may be used for it. The aperture 12 has a function for passing therethrough only the illuminance distribution as produced by the diffractive optical element.

The multiple-beam producing means 14 comprises a fly's eye lens having a plurality of small lenses, or a fiber bundle, for example. A surface light source defined by a plurality of point light sources is formed on the light exit surface of the multiple-beam producing means. The small lenses constituting the fly's eye lens may be provided by a diffractive optical element or, alternatively, a micro-lens array. In this embodiment, multiple-beam producing means 14 refers to an optical element having plural optical axes and plural regions of finite areas around these optical axes, respectively, wherein, in each region, one light flux can be specified.

The laser beam emitted from the laser light source 1 is directed by way of the light directing optical system 2, including a mirror and a relay lens (not shown), and it enters the beam shaping optical system 3, which comprises a cylindrical lens and a mirror, for example. The beam sectional shape of the laser beam is transformed into a desired shape, by this beam shaping optical system 3. Then, the light enters the emission angle conserving optical unit 4.

Here, as shown in Figure 2A, the emission angle conserving optical unit 4 comprises an aperture 21 and a lens system 22. It has such a property that, even if the optical axis of the incident light shifts slightly as depicted at 27 or 28 in the drawing, the emission angle 29a of the light emitted therefrom is maintained constant. Alternatively, as shown in Figure 2B, the emission angle conserving optical unit 4 may be provided by a fly's eye lens having small

lenses. ~~In~~ On that occasion, the emission angle  $29b$  of the light is determined by the shape of the fly's eye lens. With the use of an emission angle conserving optical unit comprising a fly's eye lens such as shown in Figure 2B, the emission angle  $29b$  of the emitted light can be held constant.

The light emitted from the emission angle conserving optical unit 4 at a desired emission angle  $\alpha$  is collected by the condenser optical system 5, and it is directed to another emission angle conserving optical unit 6. Here, the light exit surface of the optical unit 4 and the light entrance surface of the optical unit 6 are placed in the relation of Fourier transform planes (the relation of an object plane and a pupil plane, or the relation of a pupil plane and an image plane), through the condenser optical system 5. Further, the emission angle  $\alpha$  is held fixed. Therefore, even if the position of the light beam from the laser light source 1 shifts, the distribution of the light incident on the light entrance surface of the optical unit 6 is held fixed at the same position on the plane, constantly.

The emission angle conserving optical unit 6 has a similar structure and a similar function as ~~of~~ those of the optical unit 4 described above, and the emission angle  $\beta$  of the light emitted therefrom is constant.

The light emitted from the optical unit 6 at a desired emission angle  $\beta$  is collected by the relay optical systems 7 and 9, and it is directed to the diffractive optical element 10. In this embodiment, the diffractive optical element 10 is disposed at or adjacent to a position which is optically conjugate with the light exit surface of the optical unit 6. With this structure, even if the light from the light source changes slightly, the incidence position and the divergent angle (or convergent angle) of the light entering the diffractive optical element 10 can always be controlled at desired values. As a result, the light intensity distribution to be

produced at the surface can always be maintained constant. In Figure 1, the element is disposed at a position slightly deviated from the convergence point P of the light rays emitted from arbitrary points on the light exit surface of the optical unit 6 (i.e., adjacent to a position optically conjugate with the light exit surface of the optical unit 6), and it is illuminated with incident light having a divergent angle (convergent angle)  $\gamma$ . This will be described in detail, with reference to Figures 3A and 3B.

Figures 3A and 3B illustrate the state of incident light on the diffractive optical element 10. In these drawings, denoted at 31 is the surface of a diffractive optical element having a very fine step-like sectional structure formed on a substrate such as quartz, for example. Denoted at 32a and 32b is a single light spot to be produced by light from a single small lens, where the optical unit 6 comprises a fly's eye lens and where small lenses constituting the fly's eye lens have a honeycomb structure. Namely, a light beam provided by a large number of light spots 32a or 32b provide a light flux impinging on the diffractive optical element 10. Here, the width D of the light flux in Figure 3A or 3B corresponds to the width D defined in Figure 1 by broken lines intersecting the diffractive optical element 10.

The size of each light spot 32a or 32b differs with the relative distance between the diffractive optical element 10 and the convergence point P (i.e., deviation from the conjugate position of the light exit surface of the optical unit 6). By making this relative distance large, as shown in Figure 3B, the size of the light spot 32b may be made large, such that the light spots are superposed one upon another on the diffractive optical element surface 31. By disposing the diffractive optical element 10 adjacent to the conjugate position of the light exit surface of the optical unit 6, as shown in Figure 3B, damage ~~of~~ to the element due to the energy concentration upon the diffractive optical element surface 31 can be prevented. The

distance from the conjugate position of the light exit surface of the optical unit 6 whereat the diffractive optical element 10 is disposed, may preferably be kept so that a portion of the light spots 32b comes out of the diffractive optical element 10 surface.

Referring to Figures 4A and 4B, the diffractive optical element 10 will be explained. In this embodiment, a phase type computer hologram (CGH: Computer Generated Hologram) is used as the diffractive optical element 10. A computer hologram is a hologram which can be produced by calculating an interference fringe pattern to be formed by interference between object light and reference light and by directly outputting it by use of a pattern forming machine. An interference fringe shape to obtain a desired illuminance distribution as reproduced light can be easily determined by optimization based on repetition of calculations made by use of a computer. Figure 4A is a front view of a phase type CGH produced in this manner. Figure 4B schematically shows a sectional view along an arrow in Figure 4A. In Figure 4A, the phase distribution is illustrated by a tone distribution such as at 41. If the section is formed with a step-like shape such as depicted at 42 in Figure 4B, the semiconductor device manufacturing technology can be applied to the manufacture of the same. Thus, a step-like structure having a very fine pitch can be produced relatively easily.

As regards the term “desired illuminance distribution” to be produced by the diffractive optical element 10, it may be a circular illuminance distribution (Figure 5A), a ring-like illuminance distribution (Figure 5B), or an illuminance distribution called a quadrupole (Figure 5C), all being suitable in accordance with the exposure condition used. The illuminance distribution defined by the diffractive optical element 10 is projected onto the light entrance surface of the multiple-beam producing optical system 14, by means of the zoom optical system 13 (to be described later). Thus, the above-described arrangement

provides modified or deformed illumination (oblique incidence illumination) means in an illumination system of a semiconductor exposure apparatus, which accomplishes improvements in the resolution performance. Further, a plurality of diffractive optical elements may be mounted on interchanging means such as a turret (not shown), so that they can be used interchangeably to change the illumination condition.

Referring back to Figure 1, the light beam incident on the diffractive optical element 10 is amplitude-modulated or phase-modulated as calculated, and it is diffracted thereby. The light goes through the relay optical system 11, and a desired illuminance distribution 12a (as ~~that of Figure~~ Figures 5A, 5B or 5C) having a substantially uniform intensity within the distribution is produced at the position of the aperture 12.

Here, the diffractive optical element 10 and the aperture 12 are placed in the relation of Fourier transform planes. Based on this relationship, light diverged from an arbitrary single point on the diffractive optical element 10 contributes to the ~~while~~ whole illuminance distribution 12a. Namely, in Figures 3A and 3B, by an arbitrary light beam which forms the light spot 32a or 32b, regardless of its irradiation position, an illuminance distribution 12a (as in Figures 5A - 5C) suitable for the illumination can be produced at the aperture 12 position.

Here, in the illumination distribution 12a, since the light incident on the diffractive optical element 10 (CGH) has an extension angle  $\gamma$ , there occurs a small blur corresponding to this angle. The diffractive optical element 10 may be designed, as a matter of course, to produce a desired illuminance distribution while taking into account such blur, beforehand.

Next, a description will be made ~~on~~ of the magnification change of the zoom optical system 13. A desired illuminance distribution 12a being substantially uniform within the distribution and being formed by the diffractive optical element 10, is projected by the zoom



optical system 13 onto the light entrance surface of the multiple-beam producing optical system 14 at a desired magnification, as a uniform light source image 14a. Here, the term “desired magnification” refers to a magnification which functions to set the size of the uniform light source image so that the incidence angle  $\zeta$  of the projected light on the surface 16 to be illuminated has a value best suited to the exposure.

If, in with respect to a desired magnification  $m$ , the light entrance side NA (numerical aperture) of the zoom optical system 13 as determined by the angle  $\delta$  is  $NA'$ , and the light exit side NA (numerical aperture) of the zoom optical system as determined by the angle  $\epsilon$  is  $NA''$ , the following relation is obtained:

$$NA' = m \cdot NA'' \quad \dots (1)$$

Here, as regards the magnitude of the angle  $\epsilon$ , from the standpoint of illumination efficiency, preferably, it should be close, as much as possible to, but not exceeding, the NA with which the light can enter the multiple-beam producing means 14. Therefore, an optimum angle being dependent upon the the multiple-beam producing means 14 is set. Thus, as seen from equation (1), once an optimum magnification for the exposure process in a certain condition is determined, the optimum angle of  $\delta$  is also determined.

In this embodiment, the value of angle  $\delta$  depends on the size of the width  $D$  (Figure 3A or 3B) of the irradiation region of the light being incident on the diffractive optical element 10, and the magnitude thereof is dependent upon the emission angle  $\alpha$  from the optical unit 4. On the basis of this, the emission angle conserving optical unit 4 is interchanged in accordance with the illumination condition, to change the width  $D$  of the irradiation region of the light impinging on the diffractive optical element 10. This will be described later in detail, with reference to Figure 6.

When a uniform light source image is projected on the light entrance surface of the multiple-beam producing means 14 in the manner described above, the illuminance distribution on the light entrance surface is directly transferred to the light exit surface thereof. Then, light beams emitted from small regions of the multiple-beam producing means 14 are projected by the projecting means 15 onto the surface 6, to be illuminated, while beams are superposed one upon another. By this, the surface 16 can be illuminated with a generally uniform illuminance distribution.

Referring to Figures 6A and 6B, interchanging control of the emission angle conserving optical unit 4 will be described. In these drawings, denoted at 4a is an emission angle conserving optical unit having a smaller emission angle  $\alpha a$ . Denoted at 4b is another emission angle conserving optical unit having a larger emission angle  $\alpha b$ . The remaining elements are similar to those having been described with reference to Figure 1.

Generally, in an illumination system to be used in an illuminance unit of a semiconductor device manufacturing exposure apparatus, it is required that the incidence angle of light to be projected on the surface to be illuminated can be set as desired. In this embodiment, a plurality of emission angle conserving optical units such as at 4a and 4b in Figure 6 are mounted on a switching means such as a turret (not shown), and these optical units are interchangeably used in accordance with the requirement. With this arrangement, a desired incidence angle can be set to the light to be incident on the surface to be illuminated.

Figure 6A corresponds to a case wherein the incident angle  $\zeta a$  of the light incident on the surface 16 is relatively small (this being called ~~as~~ a small  $\sigma$  value). In this embodiment, in order to make the  $\sigma$  value small, the image 14a of the illuminance distribution to be produced by the diffractive optical element 10 on the light entrance surface of the multiple-beam

producing means 14 should be imaged at a small magnification. Although this can be accomplished by changing the magnification of the zoom optical system 13, as described hereinbefore, the value  $\zeta_a$  is set at an optimum angle dependent upon the entrance side NA of the multiple-beam producing means 14.

Therefore, as seen from equation (1), once the magnification for attaining a desired  $\sigma$  value is determined, the divergent angle  $\zeta_a$  of the light of the illuminance distribution, produced by the diffractive optical element 10 at the position of the aperture 12, is determined fixedly. While the angle  $\delta_a$  is determined by the width  $D_a$  of light incident on the diffractive optical element 10, this width is dependent upon the width  $6a$  of light impinging on the optical unit 6. Thus, the emission angle conserving optical unit is changed to the unit 4a to set a smaller emission angle  $\alpha_a$ , thereby to narrow the light flux width  $6a$ . With this procedure, illumination of a high efficiency and with a small angle  $\zeta_a$  (small  $\sigma$  value) is accomplished.

On the other hand, Figure 6B shows an example where the  $\sigma$  value is large. In this case, the emission angle conserving optical unit is changed to the unit 4b having a larger emission angle, to set the large emission angle  $\alpha_b$ . By this, the width  $D_b$  of light incident on the diffractive optical element 10 is made large, and the angle  $\delta_b$  of light diverged from the illuminance distribution as produced by the diffractive optical element 10 is made large. Even though the image 14b thereof is projected on the multiple-beam producing means 14 at a large magnification, from the relation of equation (1), the angle  $\epsilon_b$  can be set to be substantially the same as the above-described ~~angle~~ angle  $\epsilon_a$ . With this procedure, illumination of a high efficiency and with a large angle  $\zeta_b$  (large  $\sigma$  value) is accomplished.

As regards the divergent angle of the light diverged from the diffractive optical element 10, since the angle  $\gamma_a$  (Figure 6A) and the angle  $\gamma_b$  (Figure 6B) are equal to each other, the divergent angle of diverged light is the same and, thus, the size of the illuminance distribution 12a at the aperture 12 position is unchanged even if the emission angle conserving optical units are interchanged.

As a matter of course, in order to obtain a desired illuminance distribution in response to the  $\sigma$  value changing, if necessary, the diffractive optical element 10 may be interchanged by using a switching means such as a turret (not shown), simultaneously in response to the interchange of the optical units.

As has been described with reference to Figure 2B, for example, even if the light from the laser light source 1 changes slightly due to any external disturbance, the emission angle of the light from the emission angle conserving optical unit 4 is conserved. Therefore, in Figure 1, the position of the incident light on the optical unit 6 is unchanged. Further, since the emission angle of light from the optical unit 6 is also conserved, there occurs substantially no change in the position of the incident light on the diffractive optical element 10 or in the width of the light there. Thus, when the whole light source image inside the small lenses of the multiple-beam producing means 14 is viewed macroscopically, it can be said that ~~there is~~ substantially no change has occurred. Consequently, the influence to the illuminance distribution on the surface 9 to be illuminated becomes very small so that it can be disregarded. This clearly suggests the advantages of the present invention that the system is very stable against a change of light from the laser light source.

In accordance with embodiments of illumination systems according to the present invention, described hereinbefore, the following advantageous results are obtained.

(a) The incidence angle of light to the surface to be illuminated can be set at a desired value, and non-uniformness of illuminance can be reduced while attaining high-efficiency uniform illumination.

(b) Even if there occurs a change in the light in dependence upon the laser light source, the incidence angle of the light incident on the surface to be illuminated is stable. Thus, the adverse ~~effect~~ effects of the change to the exposure can be removed.

(c) Use of a diffractive optical element, having a small glass material thickness in place of an optical pipe, ensures an illumination system having a high efficiency even in a vacuum ultraviolet region in which the transmission factor is low.

For these reasons, an illumination system suitably usable, particularly, in an illumination optical system of a semiconductor device manufacturing exposure apparatus, is provided.

Next, a description will be made ~~on~~ of an embodiment in which an illumination system of the present invention is applied to an illumination optical system of an exposure apparatus for the manufacture of semiconductor devices such as semiconductor chips (e.g., ~~IC~~ ICs or ~~LSI~~ LSIs), liquid crystal panels, CCDs, thin film magnetic heads, or micro-machines, for example.

Figure 7 is a schematic view of a general structure of a semiconductor device manufacturing exposure apparatus.

Denoted in the drawing at 71 is a beam shaping optical system for transforming light from a laser light source 1 into a desired beam shape. Denoted at 72 is an incoherency transforming optical system for transforming a coherent laser beam into incoherent light. Denoted at 73 is a projection optical system, and denoted at 74 is a photosensitive substrate

such as a wafer, for example, having a photosensitive material applied thereto. Like numerals as of those of Figure 1 are assigned to corresponding elements, and a description thereof is omitted.

The light emitted from the laser light source 1 is directed by way of a light directing optical system 2, and it enters the beam shaping optical system 71. The beam shaping optical system 71 comprises a plurality of cylindrical lenses or a beam expander, and it functions to transform the aspect ratio (longitudinal to lateral ratio) of the sectional shape of the light beam into a desired value.

The light thus shaped into a desired sectional shape by the beam shaping optical system 71 enters the incoherency transforming optical system 72 for preventing interference of light upon the wafer 74 surface and production of speckle thereon, whereby the light is transformed into incoherent light.

As regards the incoherency transforming optical system 72, an optical system such as disclosed in Japanese Laid-Open Patent Application, Laid-Open No. 215930/1991 may be used. In this optical system, the incident light is divided by a light dividing surface into at least two light beams (e.g., P-polarized light and S-polarized light) and, after an optical path length longer than the coherence length of the light is assigned to one of the divided light beams by use of an optical member, these light beams are directed again to the light dividing surface where one light beam is superposed on the other. By using a folding system such as above, mutually incoherent light beams are produced.

The incoherent light produced by the incoherency transforming optical system 72 enters the emission angle conserving optical unit 4, and it emits therefrom at a desired emission angle  $\alpha$ . The light emitted from the optical unit 4 is collected by a condenser optical

system 5 and is directed to the emission angle conserving optical unit 6. Here, the light exit surface of the optical unit 4 and the light entrance surface of the optical unit 6 are placed in the relation of Fourier transform planes through the condenser optical system 5. Further, the emission angle  $\alpha$  is held fixed. Therefore, even if the optical axis of the light from the laser light source 1 shifts, the distribution of the light incident on the light entrance surface of the optical unit 6 is held fixed at the same position on the plane, constantly.

In the embodiment of Figure 1, the light emitted from the optical unit 6 is collected by relay optical systems 7 and 9 and is directed to the diffractive optical element 10. In this embodiment, however, these relay optical systems are omitted, and the light is directly directed to the diffractive optical element 10. The diffractive optical element 10 is disposed at a position slightly deviated from the position of the light convention point P'.

In this case, the optical unit 6 may be a fly's eye lens such as shown in Figure 6B. Alternatively, to such structure, small lenses of a diffractive optical element disposed in an array may be added. For the  $\sigma$  value changing as has been described with reference to Figures 6A and 6B, the optical unit 6 and the diffractive optical element 10 may be combined into an integral unit, and this may be interchanged.

Then, with the procedure as has been described with reference to Figure 1, light beams emitted from the small regions of the multiple-beam producing means 14 are projected by the projecting means onto the surface 16 while being superposed one upon another. Thus, the surface 16 is illuminated with a generally uniform illuminance distribution. Then, the light which bears information about the circuit pattern, for example, formed on the surface 16 is projected and imaged by the projection optical system 73 onto the photosensitive substrate

74, at a magnification best suited to the exposure, whereby the circuit pattern is transferred there.

The photosensitive substrate 74 is held fixed by vacuum attraction, for example, to a photosensitive substrate stage (not shown). It can be moved in translation upwardly/downwardly and forwardly/backwardly in the sheet of the drawing. The motion thereof is controlled by means of a measuring device such as a laser interferometer (not shown), for example.

Although in this embodiment the surface 16 is illuminated with a generally uniform illuminance distribution, the emission angle of light emitted from each small region of the multiple-beam producing means 14 may be so set that different angles are defined with respect to two orthogonal directions. ~~In~~ On that occasion, the surface 16 can be illuminated with a slit-like shape.

Next, an embodiment of a semiconductor device manufacturing method, which uses an exposure apparatus such as shown in Figure 7, will be explained.

Figure 8 is a flow chart of the procedure for the manufacture of microdevices such as semiconductor chips (e.g., ICs or LSIs), liquid crystal panels, CCDs, thin film magnetic heads or micro-machines, for example.

Step 1 is a design process for designing a circuit of a semiconductor device. Step 2 is a process for making a mask on the basis of the circuit pattern design. Step 3 is a process for preparing a wafer by using a material such as silicon. Step 4 is a wafer process (called a pre-process) wherein, by using the so prepared mask and wafer, circuits are practically formed on the wafer through lithography. Step 5 subsequent to this is an assembling step (called a post-process) wherein the wafer having been processed by step 4 is formed into semiconductor



chips. This step includes an assembling (dicing and bonding) process and a packaging (chip sealing) process. Step 6 is an inspection step wherein an operation check, a durability check and so on for the semiconductor devices provided by step 5, are carried out. With these processes, semiconductor devices are completed and they are shipped (step 7).

Figure 9 is a flow chart showing details of the wafer process.

Step 11 is an oxidation process for oxidizing the surface of a wafer. Step 12 is a CVD process for forming an insulating film on the wafer surface. Step 13 is an electrode forming process for forming electrodes upon the wafer by vapor deposition. Step 14 is an ion implanting process for implanting ions to the wafer. Step 15 is a resist process for applying a resist (photosensitive material) to the wafer. Step 16 is an exposure process for printing, by exposure, the circuit pattern of the mask on the wafer through the exposure apparatus described above. Step 17 is a developing process for developing the exposed wafer. Step 18 is an etching process for removing portions other than the developed resist image. Step 19 is a resist separation process for separating the resist material remaining on the wafer after being subjected to the etching process. By repeating these processes, circuit patterns are superposedly formed on the wafer.

With these processes, high density microdevices can be manufactured.

In accordance with the embodiments of the present invention as described hereinbefore, even if the light from a light source changes, the illumination system can hold the uniformness of a light intensity distribution on the surface illuminated. Also, the light utilization efficiency is improved simultaneously.

While the invention has been described with reference to the structures disclosed herein, it is not confined to the details set forth and this application is intended to cover such

modifications or changes as may come within the purposes of the improvements or the scope of the following claims.

WHAT IS CLAIMED IS:

1. (Currently Amended) An illumination system for illuminating a surface by use of light from a light source, said illumination system comprising:

an emission angle conserving optical unit having ~~one of a lens and~~ a lens array, for receiving light from the light source; and

a diffractive optical element for diffracting light ~~from said emission angle conserving optical unit~~ to produce a desired light intensity distribution on a predetermined plane,

wherein said diffractive optical element is disposed ~~one of (i)~~ at or adjacent to a position ~~where the light from said emission angle conserving optical unit is focused by the one of the lens and the lens array, and (ii) at a position~~ which is optically conjugate with a light exit surface of said emission angle conserving optical unit ~~position at which the light is focused by the one of the lens and the lens array.~~

2. (Original) An illumination system according to Claim 1, further comprising a multiple-beam producing element and a light projecting element for superposing light beams from said multiple-beam producing element one upon another on the surface to be illuminated, wherein the predetermined plane corresponds to a light entrance surface of said multiple-beam producing element.

3. (Original) An illumination system according to Claim 2, further comprising a zoom optical system for projecting the light intensity distribution, produced by said

diffractive optical element, upon the light entrance surface of said multiple-beam producing element at a predetermined magnification.

4. (Original) An illumination system according to Claim 3, wherein there are a plurality of emission angle conserving optical units of different divergent angles, and wherein said emission angle conserving optical units are interchangeably set at a light path in accordance with a change in magnification of said zoom optical system.

5. (Original) An illumination system according to Claim 4, wherein an emission angle conserving optical unit placed at the light path is changed by another, whereby a numerical aperture of light incident on the light entrance surface of said multiple-beam producing element is substantially registered with a preset numerical aperture of said multiple-beam producing means.

6. (Original) An illumination system according to Claim 1, wherein there are a plurality of diffractive optical elements for producing different light intensity distributions on the predetermined plane, wherein said diffractive optical elements are interchangeably set at a light path to produce a desired light intensity distribution on the predetermined plane.

7. (Previously Amended) An illumination system according to Claim 1, wherein said diffractive optical element is one of a phase type and an amplitude type computer hologram.

8. (Previously Amended) An illumination system according to Claim 1, wherein said emission angle conserving optical unit comprises a fly's eye lens having small lenses arrayed two-dimensionally.

9. (Cancelled)

10. (Currently Amended) An exposure apparatus, comprising:

an illumination optical system for illuminating a mask surface, as a surface to be illuminated, with use of light from a light source, said illumination optical system including (i) an emission angle conserving optical unit having ~~one of~~ a lens and an aperture or a lens array, for receiving light from the light source, and (ii) a diffractive optical element for diffracting light from said emission angle conserving optical unit to produce a desired light intensity distribution on a predetermined plane, wherein said diffractive optical element is disposed ~~one of (i) at or adjacent to a position where the light from said emission angle conserving optical unit is focused by the one of the lens and the lens array and (ii) at a position~~ which is optically conjugate with a light exit surface of said emission angle conserving optical unit ~~position at which the light is focused by the one of the lens and the lens array~~; and

a projection optical system for projecting a pattern formed on the mask surface, as illuminated with light from said illumination optical system, onto a wafer.

11. (Currently Amended) A device manufacturing method, comprising the steps of:

applying a photosensitive material to a wafer;

illuminating a mask surface, as a surface to be illuminated, with use of light from an illumination optical system, wherein the illumination optical system includes (i) an emission angle conserving optical unit having ~~one of~~ a lens and an aperture or a lens array, for receiving light from the light source, and (ii) a diffractive optical element for diffracting light from ~~said the~~ the emission angle conserving optical unit to produce a desired light intensity distribution on a predetermined plane, and wherein the diffractive optical element is disposed ~~one of (i)~~ at or adjacent to a position ~~where the light from the emission angle conserving optical unit is focused by the one of the lens and the lens array and (ii) at a position~~ which is optically conjugate with a light exit surface of said emission angle conserving optical unit ~~position at which the light is focused by the one of the lens and the lens array;~~

projecting, through a projection optical system, a pattern formed on the mask surface onto a wafer; and

developing the transferred pattern.

## ABSTRACT OF THE DISCLOSURE

~~Disclosed is an illumination system for illuminating a surface by use of light from a light source, which includes an emission angle conserving optical unit effective to emit the light from the light source at a constant divergent angle, and a diffractive optical element for producing a desired light intensity distribution on a predetermined plane, wherein the diffractive optical element is disposed at or adjacent a position where light from the emission angle conserving optical unit is collected.~~

-- An illumination system for illuminating a surface by use of light from a light source. The system includes an emission angle conserving optical unit having a lens array, for receiving light from the light source, and a diffractive optical element for diffracting light to produce a desired light intensity distribution on a predetermined plane. The diffractive optical element is disposed at or adjacent to a position which is optically conjugate with a light exit surface of said emission angle conserving optical unit. --